

ST13003

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

APPLICATIONS:

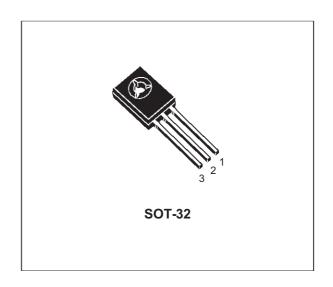
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

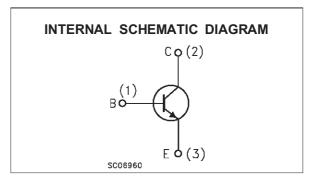
DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The device is designed for use in lighting applications and low cost switch-mode power supplies.





ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|---|-------------------|------|
| V _{CES} | Collector-Emitter Voltage (V _{BE} = 0) | 700 | V |
| V _{CEO} | Collector-Emitter Voltage (I _B = 0) | 400 | V |
| V _{EBO} | Emitter-Base Voltage $(I_C = 0, I_B = 0.75 \text{ A}, t_p < 10 \mu \text{s}, T_j < 150 ^{\circ}\text{C})$ | BV _{EBO} | V |
| Ic | Collector Current | 1.5 | Α |
| I _{CM} | Collector Peak Current (t _p < 5 ms) | 3 | Α |
| Ι _Β | Base Current | 0.75 | Α |
| I _{BM} | Base Peak Current (t _p < 5 ms) | 1.5 | Α |
| Ptot | Total Dissipation at T _c = 25 °C | 40 | W |
| T _{stg} | Storage Temperature | -65 to 150 | °C |

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THERMAL DATA

| R _{thj-case} | Thermal Resistance Junction-case | Max | 3.12 | °C/W |
|-----------------------|-------------------------------------|-----|------|------|
| R _{thj-amb} | Thermal Resistance Junction-ambient | Max | 89 | °C/W |

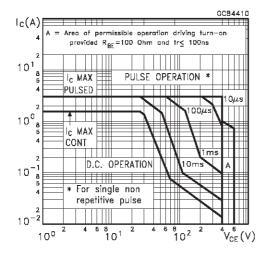
ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

| Symbol | Parameter | Test Conditions | | Min. | Тур. | Max. | Unit |
|----------------------------------|---|--|---|--------------|------|-------------------|----------------|
| I _{CEV} | Collector Cut-off Current (V _{BE} = -1.5V) | V _{CE} = 700V V _{CE} = 700V | T _j = 125°C | | | 1 5 | mA mA |
| BV _{EBO} | Emitter-Base Breakdown Voltage (I _C = 0) | I _E = 10 mA | | 9 | | 18 | V |
| V _{CEO(sus)*} | Collector-Emitter Sustaining Voltage (I _B = 0) | I _C = 10 mA L = 25mH | | 400 | | | V |
| V _{CE(sat)*} | Collector-Emitter Saturation Voltage | I _C = 0.5 A I _C = 1 A I _C = 1.5 A | $I_B = 0.1 A$ $I_B = 0.25 A$ $I_B = 0.5 A$ | | | 0.5 1 3 | V V V |
| V _{BE(sat)*} | Base-Emitter Saturation Voltage | I _C = 0.5 A I _C = 1 A | I _B = 0.1 A I _B = 0.25 A | | | 1.0 1.2 | V V |
| h _{FE} | DC Current Gain | I _C = 0.5 A Group A Group B I _C = 1 A | V _{CE} = 2 V V _{CE} = 2 V | 8 15 5 | | 20 35 25 | |
| t _r t _s | RESISTIVE LOAD Rise Time Storage Time Fall Time | I _C = 1 A I _{B1} = 0.2 A T _p = 25 μs | V _{CC} = 125 V I _{B2} = -0.2 A | | | 1.0 4.0 0.7 | μs μs μs |
| ts | INDUCTIVE LOAD Storage Time | I _C = 1 A V _{BE} = -5 V V _{clamp} = 300 V | I _{B1} = 0.2 A L = 50 mH | | 0.8 | | μs |

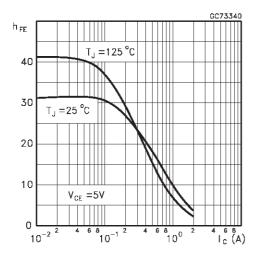
* Pulsed: Pulse duration = 300μs, duty cycle = 1.5 %
Note: Product is pre-selected in DC current gain (GROUP A and GROUP B). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicroelectronics sales office for delivery details.

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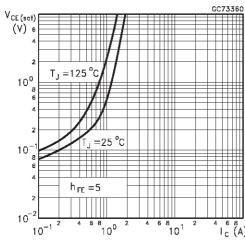
Safe Operating Areas



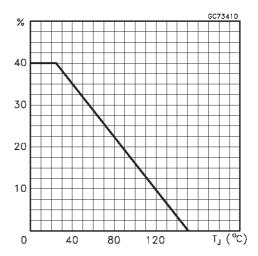
DC Current Gain



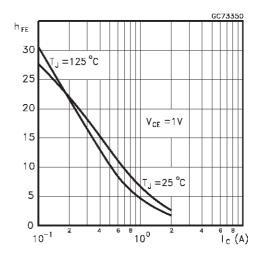
Collector Emitter Saturation Voltage



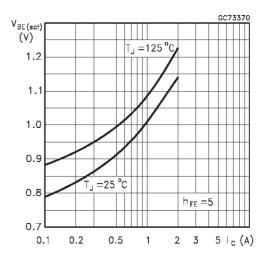
Derating Curve



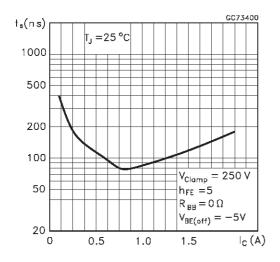
DC Current Gain



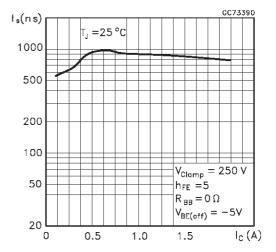
Base Emitter Saturation Voltage



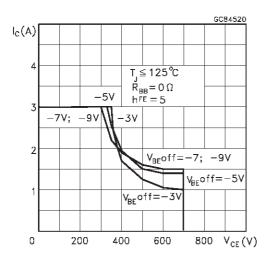
Inductive Fall Time



Inductive Storage Time



Reverse Biased SOA



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Figure 1: Inductive Load Switching Test Circuits.

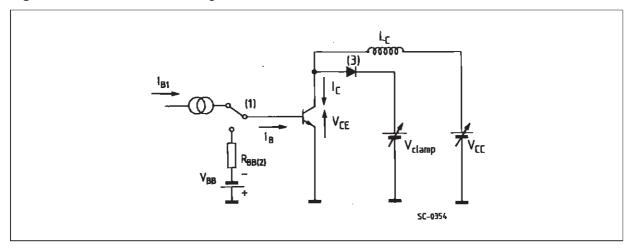
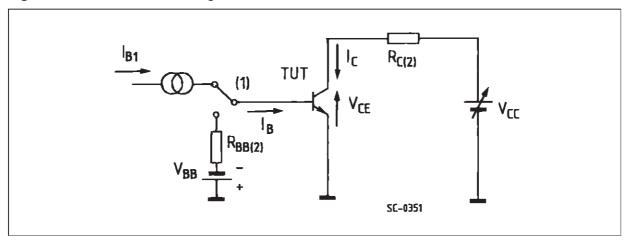
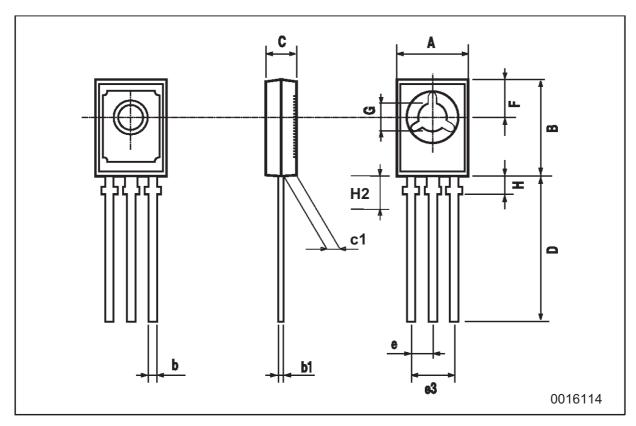


Figure 2: Resistive Load Switching Test Circuits.



SOT-32 (TO-126) MECHANICAL DATA

| DIM. | mm | | inch | | | |
|--------|------|------|------|-------|-------|-------|
| Dilwi. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| А | 7.4 | | 7.8 | 0.291 | | 0.307 |
| В | 10.5 | | 10.8 | 0.413 | | 0.445 |
| b | 0.7 | | 0.9 | 0.028 | | 0.035 |
| b1 | 0.49 | | 0.75 | 0.019 | | 0.030 |
| С | 2.4 | | 2.7 | 0.040 | | 0.106 |
| c1 | 1.0 | | 1.3 | 0.039 | | 0.050 |
| D | 15.4 | | 16.0 | 0.606 | | 0.629 |
| е | | 2.2 | | | 0.087 | |
| e3 | 4.15 | | 4.65 | 0.163 | | 0.183 |
| F | | 3.8 | | | 0.150 | |
| G | 3 | | 3.2 | 0.118 | | 0.126 |
| Н | | | 2.54 | | | 0.100 |



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